











Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0,015mm	3,5
4		Top Copper	Copper	0,035mm	
5		Dielectric 1	FR-4	0,200mm	4,2
6		FUSED_VBAT-	Copper	0,035mm	
7		Dielectric 2	FR-4	0,350mm	4,2
8		Signal Layer 2	Copper	0,035mm	
9		Dielectric 3	FR-4	0,360mm	4,2
10		Signal Layer 3	Copper	0,035mm	
11		Dielectric 4	FR-4	0,350mm	4,2
12		VREG	Copper	0,035mm	
13		Dielectric 5	FR-4	0,200mm	4,2
14		Bot Copper	Copper	0,035mm	
15		Bottom Solder	Solder Resist	0,015mm	3,5
16		Bottom Overlay			
17		Bottom Paste			
	Height : 1,700mm				